	PC SSOCIATION CONNECTING SECTRONICS INDUSTRIES®	© Copyright 2	al Compo 2005. IPC, Bannoo onal and Pan-Amer	kburn, Illinois	. All rights reserve	tion with lov		parts, the	declaratio	n encompas	sses all lowe		for which	ne item is an assembly the manufacturer has declaration.	
IPC	-1752-2 v1.02		Site for Informativ.ipc.org/IPC-1	rd	Form Type *			Declaration Class *							
Sup	plier Information														
Company Name *		Comp	Company Unique ID		Unique ID Authority		Res	Response Date *		Response Document ID					
Contact Name *		Title -	Title - Contact		Phone - Contact *		Ema	Email - Contact *							
Aut	horized Representati	ve * Title -	Representativ	Э	Phone - Rep	resentative *	Ema	il - Repres	entative	* Sup	plier Comm	ents or URL for	Additional	nformation	
	Requester Item Numbe	r Mfr Ite	m Number		Mfr Item Name		Effec	tive Date	Version	Manufactur	ing Site	Weight	UOM	Unit Type	
	Alternate Recommendation								Alternate	Item Comm	ents				
Ма	nufacturing Proces	ss Informa	ation				·				·				
Terminal Plating / Grid Array Mat		Material	aterial Terminal E		ase Alloy	J-STD-020 MSL	Rating	Peak Process Body Ten		Temperatur	e Max Time	x Time at Peak Temperature		e Number of Reflow Cycles	
										С		second	ds		
Com	nments														

Save the fields this form to a fil			Locked				
RoHS Materia	l Composition Declaration	Declaration Type *					
	RoHS Definition: Quantity limit of 0.1% by mass (1000 PPM) in homogene Polybrominated Diphenyl Ethers (PBDE) and quantity limit of 0.01% by mas		ed Biphenyls (PBB),				
RoHS Declarati	on *	Supplier Acceptance					
•	e declared item does not contain RoHS restricted substances per the definition ab	ove except for defined RoHS exemptions, then select the corresponding response	in the RoHS Declaration				
above and checkb	oxes will appear below. Check all applicable exemptions.						
1. Mercury in com	pact fluorescent lamps not exceeding 5 mg per lamp.	7c. Lead in electronic ceramic parts (e.g. piezoelectronic devices).					
2a. Mercury in stra lamps	ight fluorescent lamps for general purposes not exceeding 10 mg in halophosphate	banned under Directive 91/338/EEC amending Directive 76/769/EEC relating to restrictions on the					
		marketing and use of certain dangerous substances and preparations piezoelectrons	onic devices).				
2b. Mercury in stra lamps with a norm	ight fluorescent lamps for general purposes not exceeding 5 mg in triphosphate al lifetime	Hexavalent chromium as an anti-corrosion of the carbon steel cooling system in absorption refrigerators					
2c. Mercury in stra lamps with long lif	ight fluorescent lamps for general purposes not exceeding 8 mg in triphosphate etime	10a. Deca BDEin polymeric applications					
3. Mercury in strai	ght fluorescent lamps for special purposes.	10b. Lead in lead-bronze bearing shells					
4. Mercury in other	r lamps not specifically mentioned in this list.	11. Lead used in compliant pin connector systems.					
5. Lead in glass o	cathode ray tubes, electronic components and fluorescent tubes.	12. Lead as a coating material for a thermal conduction module c-ring.					
6a. Lead as an all	bying element in steel containing up to 0.35% lead by weight.	13a. Lead in optical and filter glass.					
6b. Lead as an all	bying element in aluminum containing up to 0.4% lead by weight.	13b. Cadmium in optical and filter glass.					
6c. Lead as an all	bying element in copper containing up to 4% lead by weight.	14. Lead in solders consisting of more than two elements for the connection betwee package of microprocessors with a lead content of more than 80% and less than 8	•				
7a. Lead in high n weight or more lea	elting temperature type solders (i.e. lead based solder alloys containing 85% by d).	15. Lead in solders to complete a viable electrical connection between semicondu within integrated circuit Flip Chip packages.	uctor die and carrier				
	s for servers, storage and storage array systems, network infrastructure equipment alling, transmission as well as network management for telecommunications.						
Declaration S	ignature						

Instructions: Complete all of the required fields on all pages of this form. Select the "Accepted" on the Supplier Acceptance drop-down. This will display the signature area. Digitally sign the declaration (if required by the Requester) and click on Submit Form to have the form returned to the Requester.

Supplier Digital Signature

Homogeneous Material Composition Declaration for Electronic Products

Subltem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3 sigma range of distribution unless otherwise noted).

Line Functions: +P Inserts a New Part +M Inserts a new Material +C Inserts a new Substance Category +S Inserts a new Substance - Deletes the element line

Item/SubItem		Homogeneous Material	Weight	Unit of Measure	Level	Substance Category	Substance	CAS	Exempt	Weight	Unit of Measure	Tolerance		PPM
Name		Material	Weight	Measure	Levei	Cubstance Category	Gubstanoc	OAO .	Lxcmpt	Weight	Measure	-	+	
	'													
	·													
			•											

Homogeneous Material Composition Declaration for Electronic Products

Requester Instructions: The requester can optionally include additional substance categories and substances that must be declared for the item on this form. This is in addition to JIG Level A and JIG Level B substances already included for the JIG section. The requester should enter additional substance categories and then enter name of the substance and the CAS number. These entries will be accessible to the supplier via Level drop-down by selecting "Requester". Use the Load "Requester" and Test button to view the entries, just select "Requester" in the Level drop-down list in the previous section.

Substance Category	Substance	CAS			